

Rev. V2

#### Features

- Wide Frequency Range: 50 MHz to 6 GHz, in 3 bands
- Surface Mount SP2T Switch in Compact Outline: 8 mm L x 5 mm W x 2.5 mm H
- Higher Average Power Handling than Plastic Packaged
- MMIC Switches: 125 W CW
- High RF Peak Power: 500 W
- Low Insertion Loss: 0.25 dB
- High IIP3: 65 dBm
- Operates From Positive Voltage Only: 5 V & 28 V to 125 V
- RoHS\* Compliant

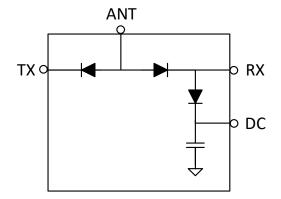
### Description

The MSW200x-200 series of surface mount silicon PIN diode SP2T switches handle high power signals from 50 MHz to 1 GHz (MSW2000), 400 MHz to 4 GHz (MSW2001) and 2 to 6 GHz (MSW2002), in transmit-receive (TR), active receiver protection and other applications. This series is manufactured using a proven hybrid manufacturing process incorporating high voltage PIN diodes and passive devices integrated within a ceramic substrate. These low profile, compact, surface mount components, offer superior small and large signal performance superior to that of MMIC devices in QFN packages. The SP2T switches are designed in an asymmetrical topology to minimize Tx-Ant loss and maximize Tx-Rx isolation performance. The very low thermal resistance (<10°C/W) of the PIN diodes in these devices enables them to reliably handle RF incident power levels of 50 dBm CW and RF peak incident power levels of 53 dBm in cold switching applications at  $T_A = 85^{\circ}$ C. The low PIN diode series resistance (<0.8  $\Omega$ ), coupled with their long minority carrier lifetime,(>2 µs), provides input third order intercept point (IIP3) greater than 65 dBm.

These MSW200x-200 series SP2T switches are designed to be used in high average and peak power switch applications, operating from 50 MHz to 6 GHz in three bands, which utilize high volume, surface mount, solder re-flow manufacturing. These products are durable and capable of reliably operating in military, commercial, and industrial environments.



**Functional Schematic** 



## **Ordering Information**

Part Number	Package
MSW2000-200-T	tube
MSW2000-200-R	250 or 500 piece reel
MSW2000-200-W	Waffle pack
MSW2001-200-T	tube
MSW2001-200-R	250 or 500 piece reel
MSW2001-200-W	Waffle pack
MSW2002-200-T	tube
MSW2002-200-R	250 or 500 piece reel
MSW2002-200-W	Waffle pack
MSW2000-200-E	RF evaluation board
MSW2001-200-E	RF evaluation board
MSW2002-200-E	RF evaluation board

\* Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

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## MSW2000-200 Electrical Specifications: $T_A = +25^{\circ}C$ , $P_{IN} = 0$ dBm, $Z_0 = 50 \Omega$

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Frequency	—	MHz	50	—	1000
TX-Ant Insertion Loss	Condition 1	dB	—	0.15	0.25
Ant-RX Insertion Loss	Condition 2	dB		0.25	0.35
TX-Ant Return Loss	Condition 1	dB	20	22	
Ant-RX Return Loss	Condition 2	dB	20	23	
TX-RX Isolation	Condition 1	dB	48	52	
RX-TX Isolation	Condition 2	dB	22	26	
TX CW Incident Power <sup>1</sup>	Condition 1, 1.5:1 Source & Load VSWR	dBm	_		50
RX CW Incident Power <sup>1</sup>	Condition 2, 1.5:1 Source & Load VSWR	dBm			43
TX Peak Incident Power <sup>1</sup>	Condition 1, 10 μs Pulse Width, 1% Duty Cycle, 1.5:1 Source & Load VSWR (IL)	dBm			57
Switching Time <sup>2</sup>	10% - 90% RF Voltage	μs	—	2	3
Input IP3	F1 = 500 MHz, F2 = 510 MHz, P1=P2=10 dBm	dBm	60	65	—

### MSW2001-200 Electrical Specifications: $T_A = +25^{\circ}C$ , $P_{IN} = 0$ dBm, $Z_0 = 50 \Omega$

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Frequency	—	MHz	400		4000
TX-Ant Insertion Loss	Condition 1	dB	_	0.3	0.4
Ant-RX Insertion Loss	Condition 2	dB	—	0.4	0.5
TX-Ant Return Loss	Condition 1	dB	15	18	
Ant-RX Return Loss	Condition 2	dB	15	17	—
TX-RX Isolation	Condition 1	dB	32	36	_
RX-TX Isolation	Condition 2	dB	12	14	—
TX CW Incident Power <sup>1</sup>	Condition 1, 1.5:1 Source & Load VSWR	dBm		_	50
RX CW Incident Power <sup>1</sup>	Condition 2, 1.5:1 Source & Load VSWR	dBm		_	43
TX Peak Incident Power <sup>1</sup>	Condition 1, 10 μs Pulse Width, 1% Duty Cycle, 1.5:1 Source & Load VSWR (IL)	dBm	_	_	57
Switching Time <sup>2</sup>	10% - 90% RF Voltage	μs	—	1.5	2.0
Input IP3	F1 = 2.0 GHz, F2 = 2.01 GHz, P1=P2=40 dBm	dBm	60	65	

Continued

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### MSW2002-200 Electrical Specifications: $T_A = +25^{\circ}C$ , $P_{IN} = 0$ dBm, $Z_0 = 50 \Omega$

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Frequency	—	GHz	2	_	6
TX-Ant Insertion Loss	Condition 1	dB	_	0.6	0.7
Ant-RX Insertion Loss	Condition 2	dB	_	0.9	1.0
TX-Ant Return Loss	Condition 1	dB	13	15	
Ant-RX Return Loss	Condition 2	dB	11	13	
TX-RX Isolation	Condition 1	dB	32	34	
RX-TX Isolation	Condition 2	dB	11	13	
TX CW Incident Power <sup>1</sup>	Condition 1, 1.5:1 Source & Load VSWR	dBm	_	_	50
RX CW Incident Power <sup>1</sup>	Condition 2, 1.5:1 Source & Load VSWR	dBm		_	43
TX Peak Incident Power <sup>1</sup>	Condition 1, 10 µs Pulse Width, 1% Duty Cycle, 1.5:1 Source & Load VSWR (IL)	dBm		_	57
Switching Time <sup>2</sup>	10% - 90% RF Voltage	μs	_	1.0	1.5
Input IP3	F1 = 500 MHz, F2 = 510 MHz, P1=P2=40 dBm	dBm	60	65	—

#### **Bias State Conditions:**

Transmit State

(TX - ANT in low insertion loss state):

- a. TX: -100 mA
- b. ANT: +100 mA
- c. RX: +25 mA, +28 V
- d. DC: -25 mA

Small Signal Receive State (ANT - RX in low insertion loss state): a. TX: +28 V b. ANT: +100 mA c. RX: -100 mA, 0 V d. DC: +28 V

- 1. PIN diode DC reverse voltage to maintain high resistance in the OFF PIN diode is determined by RF frequency, incident power, and VSWR as well as by the characteristics of the diode. The minimum reverse bias voltage values are provided in this datasheet. The input signal level applied for small signal testing is approximately 0 dBm.
- Switching time (50% TTL 10/90% RF Voltage) is a function of the PIN diode driver performance as well as the characteristics of the diode. An RC "current spiking network" is used on the driver output to provide a transient current to rapidly remove stored charge from the PIN diode. Typical component values are: R = 50 to 220 Ω and C = 470 to 1,000 pF. MACOMs MPD2T28125-700 is the recommended PIN diode driver to interface with the MSW2000-200, MSW2001-200 SP2T and MSW2002-200 switches. Its data sheet is available.

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## **Truth Table**

ANT - TX	ANT - RX	ТХ	ANT	RX	DC
Low Loss	Isolation	-100 mA	+100 mA	+25 mA @ +28 V	-25 mA
Isolation	Low Loss	+28 V	+25 mA	-25 mA	+28 V

## **Evaluation Board Truth Table**

State	Ant (P1-pin 3)	TX (P1-pin 1)	RX (P1-pin 7)	DC (P1-pin 5)
TX-ANT Low Loss & TX-RX Isolation	+5 V @ +100 mA	0 V @ +100 mA	+28 V @ +25 mA	0 V @ +25 mA
ANT-RX Low Loss & RX-TX Isolation	+5 V @ +100 mA	+28 V @ 0 mA	0 V @ +100 mA	+28 V @ 0 mA

## **RF Bias Network Component Values**

Part #	Frequency (MHz)	Inductors	DC Blocking Capacitors	RF Bypass Capacitors
MSW2000-200	50 - 1000	4.7 µH	0.1 µF	0.1 µF
MSW2001-200	400 - 4000	82 nH	27 pF	270 pF
MSW2002-200	2000 - 6000	33 nH	22 pF	33 pF

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## Minimum Reverse Bias Voltage<sup>3</sup>: $P_{INC}$ = 125 W CW, $Z_0$ = 50 $\Omega$ with 1.5:1 VSWR

Part #	20 MHz	100 MHz	200 MHz	400 MHz	1 GHz	4 GHz
MSW2000-200	120 V	110 V	85 V	55 V	28 V	N/A
MSW2001-200	N/A	N/A	110 V	85 V	55 V	28 V
MSW2002-200	(F = 1 GHz) 55 V	(F = 2 GHz) 28 V	(F = 3 GHz) 28 V	(F = 4 GHz) 28 V	(F = 5 GHz) 28 V	(F = 6 GHz) 28 V

3. N/A denotes the switch is not recommended for that frequency band.

The minimum reverse bias voltage required to maintain a PIN diode out of conduction in the presence of a large RF signal is given by:

$$|V_{DC}| = \frac{|V_{RF}|}{\sqrt{1 + \left[\left(\frac{0.0142 \times f_{MHZ} \times W_{mils}^2}{V_{RF} \times \sqrt{D}}\right) \times \left(1 + \sqrt{1 + \left(\frac{0.056 \times V_{RF} \times \sqrt{D}}{W_{mils}}\right)^2}\right)\right]^2}}$$

Where:

R. Caverly and G. Hiller, —Establishing the Minimum Reverse Bias for a PIN Diode in a High Power Switch, IEEE Transactions on Microwave Theory and Techniques, Vol.38, No.12, December 1990

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#### Absolute Maximum Ratings

Parameter	Conditions	Absolute Maximum
Forward Current	Ant, TX or RX Port DC Port	250 mA 150 mA
Reverse Voltage	TX or RX Port DC Port	200 V 200 V
Forward Diode Voltage	I <sub>F</sub> = 250 mA	1.2 V
CW Incident Power Handling <sup>4</sup>	TX or Ant Port Source & Load VSWR = 1.5:1, $T_c = 85^{\circ}C$ , cold switching	50 dBm
CW Incident Power Handling <sup>4</sup>	RX or Ant Port Source & Load VSWR = 1.5:1, $T_c$ = 85°C, cold switching	43 dBm
Peak Incident Power Handling <sup>4</sup>	RX or Ant Port Source & Load VSWR = 1.5:1, T <sub>C</sub> = 85°C, cold switching, Pulse Width = 10 μs, Duty Cycle = 1%	57 dBm
Total Dissipated RF & DC Power <sup>4</sup>	$T_{C}$ = 85°C, cold switching	3.5 W
Junction Temperature	—	+175°C
Operating Temperature	—	-65°C to +125°C
Storage Temperature	_	-65°C to +150°C
Assembly Temperature	t = 10 s	+260°C

4. Backside RF and DC grounding area of device must be completely solder attached to the RF circuit board vias for proper electrical and thermal circuit grounding.

#### **Handling Procedures**

Please observe the following precautions to avoid damage:

#### Static Sensitivity

These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these Class 1C (HBM) devices. The moisture sensitivity level (MSL) rating for this part is MSL 1.

#### **Environmental Capabilities**

The MSW204x-204 diode is capable of meeting the environmental requirements of MIL-STD-202 and MIL-STD-750.

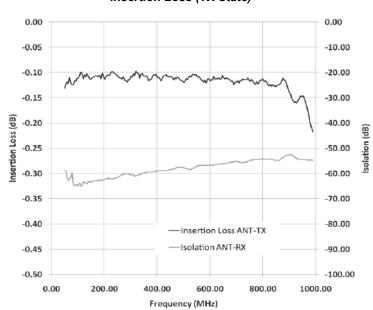
<sup>6</sup> 

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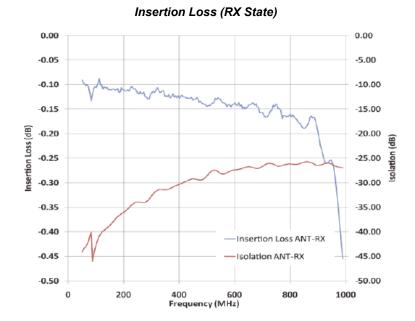


#### MSW200x-200 Rev. V2

#### Typical Performance Curves: MSW2000-200



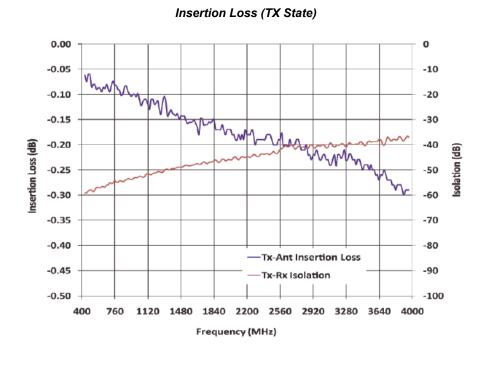
Insertion Loss (TX State)



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#### Typical Performance Curves: MSW2001-200



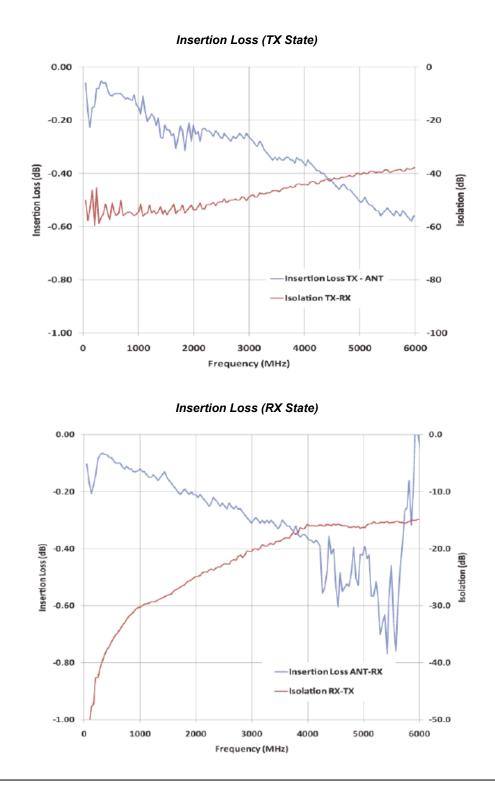
0.00 0.00 -0.05 -5.00 -0.10 -10.00  $\sim$ -0.15 -15.00 Insertion Loss (dB) -0.20 -20.00 8 tion -0.25 -25.00 Isola -0.30 -30.00 5 M MA -0.35 -35.00 -0.40 -40.00 Insertion Loss ANT-RX -0.45 -45.00 Isolation RX-TX -\_ -0.50 -50.00 1840 2200 2560 2920 3280 3640 4000 400 760 1120 1480 Frequency (MHz)

Insertion Loss (RX State)

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### Typical Performance Curves: MSW2002-200



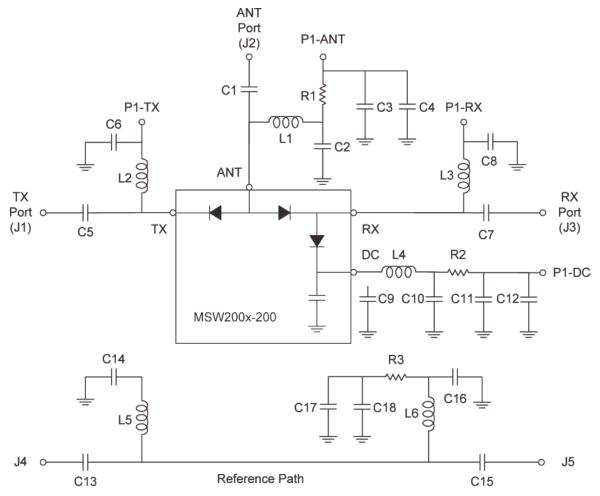
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#### MSW200x-200 Rev. V2

#### **SP2T Switch Evaluation Board Schematic**



The evaluation boards for the MSW200x-200 family of surface mount silicon PIN diode SP2T T-R switches allow the full exercise of each switch for small signal performance analysis, as well as for large signal operation with maximum input signal power of 45 dBm (CW or peak power). Each evaluation board includes the appropriate MSW200x -200 switch, DC blocking capacitors at each RF port and bias decoupling networks at each RF port which allow DC or low frequency control signals to be applied to the switch. Three complementary control signals are required for proper operation. Bias voltages are applied to the TX bias port, RX bias port and the DC bias port to control the state of the switch. A bias voltage of 5 V must be applied to the Ant Bias (pin 3 of multi-pin connector P1) port whenever the switch is in operation.

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## Transmit State

In the TX state, the series PIN diode between the ANT and TX ports is forward biased by applying 0 V to the TX bias input port (pin 1 of multi-pin connector P1). The magnitude of the resultant bias current through the diode is primarily determined by the voltage applied to the ANT bias port (pin 3 of J1), the magnitude of the forward voltage across the PIN diode and the resistance of R1. This current is nominally 100 mA. At the same time, the PIN diode connected between RX and DC ports is also forward biased by applying a higher bias voltage, nominally 28 V, to the RX bias port (pin 7 of P1) and 0 V to the DC bias port (pin 5 of P1). Under this condition, the PIN diode connected between the ANT and RX port is reverse biased and the PIN diode connected between the RX and DC ports is forward biased. The magnitude of the bias current through this diode is primarily determined by the voltage applied to the RX bias port, the magnitude of the forward voltage across the PIN diode and the resistance of R2. This current is nominally 25 mA.

The RX series PIN diode, which is connected between the ANT and RX ports, must be reverse biased during the transmit state. The reverse bias voltage must be sufficiently large to maintain the diode in its non-conducting, high impedance state when large RF signal voltage may be present in the ANT-to-TX path. The reverse voltage across this diode is the arithmetic difference of the bias voltage applied to the RX bias port and the DC forward voltage of the forward-biased transmit series PIN diode.

The minimum voltage required to maintain the series diode on the RX side of the switch out of conduction is a function of the magnitude of the RF voltage present, the standing wave present at the RX series diode's anode, the frequency of the RF signal and the characteristics of the RX series diode, among other factors. Minimum control voltages for several signal frequencies are shown in the table "Minimum Reverse Bias Voltage", assuming the input power to the RX or ANT port to be 100 W CW and the VSWR on the ANT-TX path to be 1.5:1. It is important to note that the evaluation board, as supplied from the factory, is not capable of handling RF input signals larger than 45 dBm. If performance of the switch under larger input signals is to be evaluated, an adequate heat sink must be properly attached to the

evaluation board, and several of the passive components on the board must be changed in order to safely handle the dissipated power as well as the high bias voltage necessary for proper performance. Contact the factory for recommended components and heat sink.

#### **Receive State**

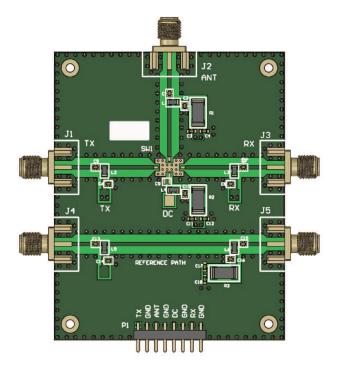
In the RX state, the series PIN diode between the ANT and RX ports is forward biased by applying 0 V to the RX bias input port (pin 7 of multi-pin connector P1). The magnitude of the resultant bias current through the diode is primarily determined by the voltage applied to the ANT bias port (pin 3 of P1), the magnitude of the forward voltage across the PIN diode and the resistance of R1. This current is nominally 100 mA. At the same time, the PIN diode connected between RX and DC ports is reverse biased by applying a high bias voltage, nominally 28 V, to the DC bias port (pin 5 of P1). A high voltage, nominally 28 V, is also applied to the TX bias port (pin 1 of P1). Under this condition, the PIN diode connected between the ANT and TX port is reverse biased thus isolating the TX RF port from the RX signal path. The reverse voltage across this diode is the arithmetic difference of the bias voltage applied to the TX bias port and the DC forward voltage of the forward-biased receive series PIN diode. The minimum voltage required to maintain the series diode on the TX side of the switch out of conduction is a function of the magnitude of the RF voltage present, the standing wave present at the RX series diode's anode, the frequency of the RF signal and the characteristics of the TX series diode, among other factors. For typical receive-level signals, this diode is held out of conduction with a relatively small reverse bias voltage. The values of the reactive components which comprise the bias decoupling networks as well as the signal path DC blocking are shown in the table RF Bias Network Component Values.

#### **Reference Path**

A reference path is provided on the evaluation board, complete with bias decoupling networks, so that the magnitude of the insertion loss of the microstrip transmission lines connected to the switch and the associated bias decoupling components can be measured and removed from the measured performance of the switch.

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## **SP2T Switch Evaluation Board Layout**

### **Evaluation Board Parts List**

MSW2000-200 Band 1				
Part	Value	Case Style		
C1, C2, C5 - C8, C13 - C16	0.1 µF	0603		
<sup>5</sup> C3, C4, C11, C12, C17, C18	0.1 µF	0603		
L1 - L6	47 µH	1008		
R1, R3	39 Ω	2512		
R2	1200 Ω	2512		

MSW2001-200 Band 2				
Part	Value	Case Style		
C1, C5, C7, C13, C15	47 pF	0603		
C2, C6, C8, C9, C10, C14, C16	220 pF	0603		
C3, C4, C11, C12, C17, C18	1000 pF	0603		
L1 - L6	43 nH	0603		
R1, R3	39 Ω	2512		
R2	1200 Ω	2512		

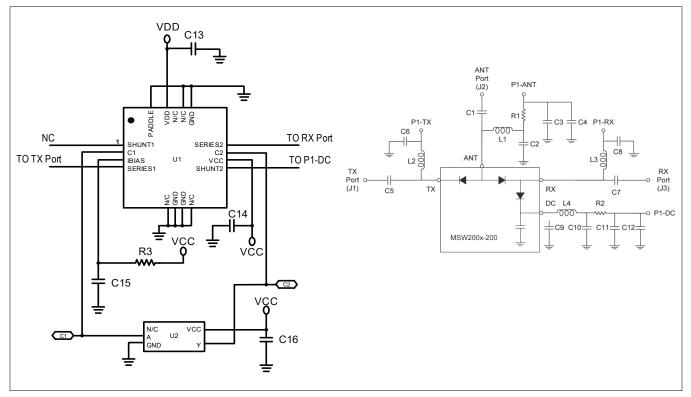
MSW2002-200 Band 3				
Part	Value	Case Style		
C1, C5, C7, C13, C15	10 pF	0603		
C2, C6, C8, C9, C10, C14	33 pF	0603		
C3, C4, C10, C11, C12, C17, C18	1000 pF	0603		
L1 - L5	8.2 nH	0603		
R1	39 Ω	2512		
R2, R3	1200 Ω	2512		

7. Second bypass capacitor is optional.

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## MSW200x-200 with MADR-010574 Driver Application Schematic<sup>8</sup>

8. See page 12 for R1, L1 - L4 and C1 - C12 values.

#### **Parts List**

Part	Value	
C13	0.01 µF	
C14 - C16	0.1 µF	
R2 <sup>9</sup>	12 ΚΩ	
R3	499 ΚΩ	
U2	SN74AHC1G	

9. Resistor value calculated to provide ~10 mA of shunt diode bias current given V\_{CC} = 5 V and V\_{DD} = 120 V.

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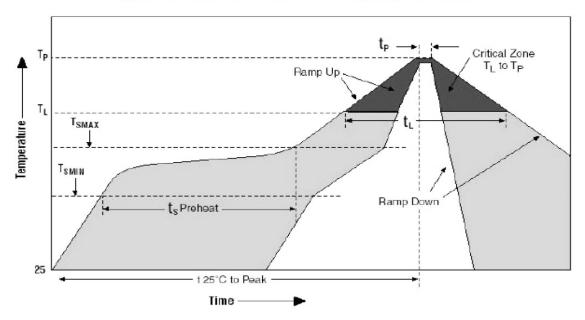
#### **Assembly Instructions**

SP2T PIN Diodes may be placed onto circuit boards with pick and place manufacturing equipment from tape and reel. The devices are attached to the circuit using conventional solder re-flow or wave soldering procedures with RoHS type or Sn 60 / Pb 40 type solders.

Profile Feature	SnPb Solder Assembly	Pb-Free Solder Assembly
Average Ramp-Up Rate $(T_{L} \text{ to } T_{P})$	3°C /second maximum	3°C /second maximum
Preheat:		
- Temperature Min $(T_{\text{SMIN}})$	100°C	150°C
- Temperature Max (T <sub>smax</sub> )	150°C	200°C
- Time (min to max)(t <sub>s</sub> )	60-120 s	60-180 s
T <sub>SMAX</sub> to T <sub>L</sub> - Ramp-Up Rate		3°C/s maximum
Time Maintained Above: - Temperature (T <sub>L</sub> ) - Time (t <sub>L</sub> )	183℃ 60-150 s	217°C 60-150 s
Peak temperature (T <sub>p</sub> )	<mark>225</mark> +0/-5°C	260 +0/-5°C
Time Within 5°C of Actual Peak Temperature (t <sub>p</sub> )	10 – 30 s	20 – 40 s
Ramp-Down Rate	6°C /s maximum	6°C /s maximum
Time 25°C to Peak Temperature	6 minutes maximum	8 minutes maximum

Table 1. Time-Temperature Profile for Sn60/Pb40 or RoHS Type Solders

#### Figure 1. Solder Re-Flow Time-Temperature Profile



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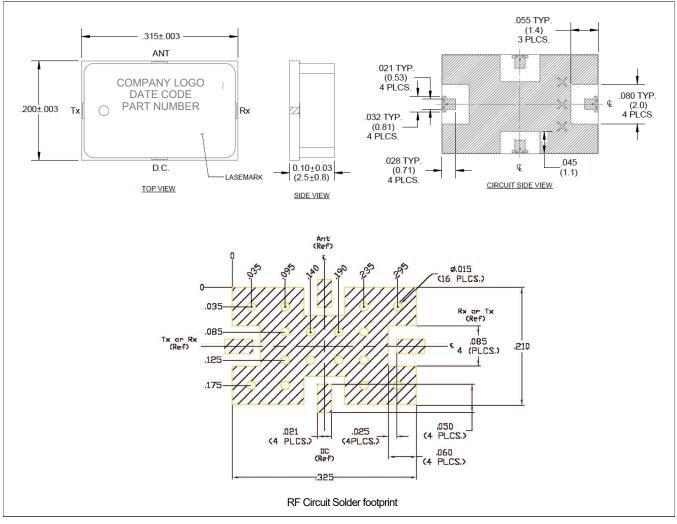
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## **SP2T PIN Diode Switch**



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## Outline (CS204)<sup>8,9</sup>



10. Hatched metal area on circuit side of device is RF, DC and thermal grounded.

11. Vias should be solid copper fill and gold plated for optimum heat transfer from backside of switch module through Circuit Vias to metal thermal ground.

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